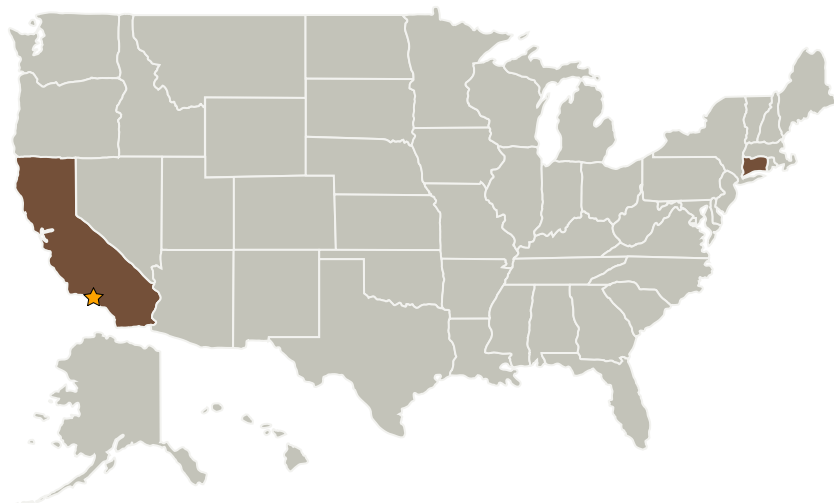


Vertical Interconnects for 3D CMOS Imager, Phase I

Completed Technology Project (2003 - 2003)



Primary U.S. Work Locations and Key Partners



Organizations Performing Work	Role	Type	Location
★ Jet Propulsion Laboratory (JPL)	Lead Organization	NASA Center	Pasadena, California
Nanosciences Corporation	Supporting Organization	Industry	Lancaster, Pennsylvania

Primary U.S. Work Locations

California	Connecticut
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Vertical Interconnects for 3D CMOS Imager, Phase I

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Organizational Responsibility

Responsible Mission Directorate:

Space Technology Mission Directorate (STMD)

Lead Center / Facility:

Jet Propulsion Laboratory (JPL)

Responsible Program:

Small Business Innovation Research/Small Business Tech Transfer

Vertical Interconnects for 3D CMOS Imager, Phase I

Completed Technology Project (2003 - 2003)



Project Management

Program Director:

Jason L Kessler

Program Manager:

Carlos Torrez

Principal Investigator:

Charles P Beetz

Technology Areas

Primary:

- TX06 Human Health, Life Support, and Habitation Systems
 - └ TX06.3 Human Health and Performance
 - └ TX06.3.5 Food Production, Processing, and Preservation